April 2004



3.3V 32K X 8 CMOS SRAM (Common I/O)

Features

- Pin compatible with AS7C3256
- Industrial and commercial temperature options
- Organization: 32,768 words × 8 bits
- High speed
 - 10/12/15/20 ns address access time
 - 5, 6, 7, 8 ns output enable access time
- Very low power consumption: ACTIVE - 180mW max @ 10 ns
- Very low power consumption: STANDBY
 - 7.2 mW max CMOS I/O

Logic block diagram

• Easy memory expansion with $\overline{\text{CE}}$ and $\overline{\text{OE}}$ inputs

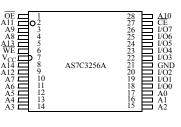
- TTL-compatible, three-state I/O
- 28-pin JEDEC standard packages - 300 mil SOJ
- 8 × 13.4 mm TSOP 1
- ESD protection ≥ 2000 volts
- Latch-up current $\ge 200 \text{ mA}$

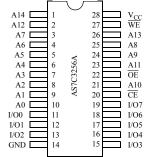
V_{CC}-GND-Input buffer रम् A0 - I/O7 A1 decoder A2 256 X 128 X 8 Sense amp A3 Array A4 -Row (262,144) A5 · A6 I/O0 Α7 - 🎧 – WE Column decoder Control OE circuit CE A A A A A 10 11 12 13 14 A 9

Pin arrangement

28-pin TSOP 1 (8×13.4 mm)

28-pin SOJ (300 mil)





Selection guide

	-10	-12	-15	-20	Unit
Maximum address access time	10	12	15	20	ns
Maximum output enable access time	5	6	7	8	ns
Maximum operating current	50	45	40	35	mA
Maximum CMOS standby current	2	2	2	2	mA

Functional description

The AS7C3256A is a 3.3V high-performance CMOS 262,144-bit Static Random-Access Memory (SRAM) device organized as $32,768 \text{ words} \times 8$ bits. It is designed for memory applications requiring fast data access at low voltage, including PentiumTM, PowerPCTM, and portable computing. Alliance's advanced circuit design and process techniques permit 3.3V operation without sacrificing performance or operating margins.

The device enters *standby mode* when \overline{CE} is high. CMOS standby mode consumes 7.2 mW. Normal operation offers 75% power reduction after initial access, resulting in significant power savings during CPU idle, suspend, and stretch mode.

Equal address access and cycle times (t_{AA} , t_{RC} , t_{WC}) of 10/12/15/20 ns with output enable access times (t_{OE}) of 5, 6, 7, 8 ns are ideal for high-performance applications. The chip enable (\overline{CE}) input permits easy memory expansion with multiple-bank memory organizations.

A write cycle is accomplished by asserting chip enable (\overline{CE}) and write enable (\overline{WE}) LOW. Data on the input pins I/O0-I/O7 is written on the rising edge of \overline{WE} (write cycle 1) or \overline{CE} (write cycle 2). To avoid bus contention, external devices should drive I/O pins only after outputs have been disabled with output enable (\overline{OE}) or write enable (\overline{WE}).

A read cycle is accomplished by asserting chip enable (\overline{CE}) and output enable (\overline{OE}) LOW, with write enable (\overline{WE}) high. The chip drives I/O pins with the data word referenced by the input address. When chip enable or output enable is high, or write enable is low, output drivers stay in high-impedance mode.

All chip inputs and outputs are TTL-compatible. Operation is from a single 3.3 ± 0.3 V supply. The AS7C3256A is packaged in high volume industry standard packages.

Parameter	Symbol	Min	Max	Unit
Voltage on V _{CC} relative to GND	V _{t1}	-0.5	+5.0	V
Voltage on any pin relative to GND	V _{t2}	-0.5	V _{CC} + 0.5	V
Power dissipation	P _D	-	1.0	W
Storage temperature (plastic)	T _{stg}	-65	+150	°C
Ambient temperature with V _{CC} applied	T _{bias}	-55	+125	°C
DC current into outputs (low)	I _{OUT}	-	20	mA

Absolute maximum ratings

Stresses greater than those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Truth table

CE	WE	OE	Data	Mode
Н	Х	Х	High Z	Standby (I_{SB}, I_{SB1})
L	Н	Н	High Z	Output disable (I _{CC})
L	Н	L	D _{OUT}	Read (I _{CC})
L	L	Х	D _{IN}	Write (I _{CC})

Key: X = Don't care, L = Low, H = High



Recommended operating conditions

Parameter	Symbol	Min	Typical	Max	Unit	
Supply voltage	V _{CC}	3.0	3.3	3.6	V	
Input voltage	V _{IH} **	2.0	_	V _{CC} +0.5	V	
input voltage	input voltage			_	0.8	V
Ambient operating temperature	commercial	T _A	0	_	70	°C
Ambient operating temperature	industrial	T _A	-40	_	85	°C

 $V_{IL} \min = -1.0V \text{ for pulse width less than 5ns.}$ $V_{IH} \max = V_{CC} + 2.0V \text{ for pulse width less than 5ns.}$

DC operating characteristics (over the operating range)¹

			-]	10	-12		-]	15	-2	20	
Parameter	Sym	Test conditions	Min	Max	Min	Max	Min	Max	Min	Max	Unit
Input leakage current	I _{LI}	$V_{CC} = Max,$ $V_{in} = GND \text{ to } V_{CC}$	_	1	_	1	_	1	_	1	μΑ
Output leakage current	$\left I_{LO} \right $	$V_{CC} = Max,$ $V_{OUT} = GND$ to V_{CC}	_	1	_	1	_	1	_	1	μΑ
Operating power supply current	I _{CC}	$V_{CC} = Max, \overline{CE} \le V_{IL}$ $f = f_{Max}, I_{OUT} = 0mA$	_	50	_	45	_	40	_	35	mA
Standby power	I _{SB}	$V_{CC} = Max, \overline{CE} \ge V_{IH}$ $f = f_{Max}$	Ι	20	_	20	_	20	Ι	20	mA
supply current	I _{SB1}	$\begin{split} & V_{CC} = Max, \ \overline{CE} \geq V_{CC} - 0.2V \\ & V_{IN} \leq 0.2V \ \text{or} \\ & V_{IN} \geq V_{CC} - 0.2V, \ f = 0 \end{split}$	_	2.0	_	2.0	_	2.0	_	2.0	mA
Output voltage	V_{OL}	$I_{OL} = 8 \text{ mA}, V_{CC} = Min$	-	0.4	-	0.4	-	0.4	-	0.4	V
Sulput Voltage	V _{OH}	$I_{OH} = -4 \text{ mA}, V_{CC} = Min$	2.4	_	2.4	-	2.4	—	2.4	-	V

Capacitance (f = 1MHz, T_a = room temperature, V_{CC} = NOMINAL)²

Parameter	Symbol	Signals	Test conditions	Max	Unit
Input capacitance	C _{IN}	A, \overline{CE} , \overline{WE} , \overline{OE}	$V_{in} = 0V$	5	pF
I/O capacitance	C _{I/O}	I/O	$V_{in} = V_{out} = 0V$	7	pF



		-]	-10		12	-15		-2	20		
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Notes
Read cycle time	t _{RC}	10	_	12	_	15	-	20	-	ns	
Address access time	t _{AA}	_	10	l	12	_	15	_	20	ns	3
Chip enable (\overline{CE}) access time	t _{ACE}	-	10	-	12	-	15	-	20	ns	3
Output enable (\overline{OE}) access time	t _{OE}	_	5	-	6	_	7	_	8	ns	
Output hold from address change	t _{OH}	3	-	3	_	3		3		ns	5
CE LOW to output in low Z	t _{CLZ}	3	_	3	_	3	_	3	_	ns	4, 5
CE HIGH to output in high Z	t _{CHZ}	_	3	-	3	_	4	_	5	ns	4, 5
OE LOW to output in low Z	t _{OLZ}	0	_	0	_	0	-	0		ns	4, 5
OE HIGH to output in high Z	t _{OHZ}	_	3	_	3	_	4	-	5	ns	4, 5
Power up time	t _{PU}	0	-	0	-	0	_	0	_	ns	4, 5
Power down time	t _{PD}	_	10		12	1	15	1	20	ns	4, 5

Read cycle (over the operating range)^{3,9}

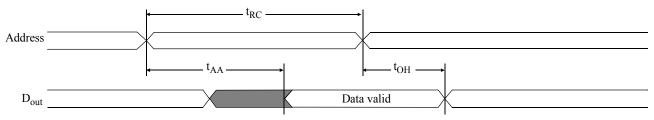
Key to switching waveforms

Rising input

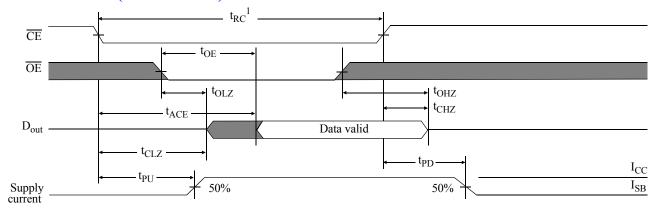
— Falling input

Undefined output/don't care

Read waveform 1 (address controlled)^{3,6,7,9}



Read waveform 2 (CE controlled)^{3,6,8,9}

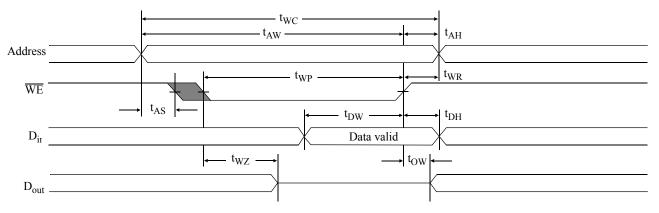




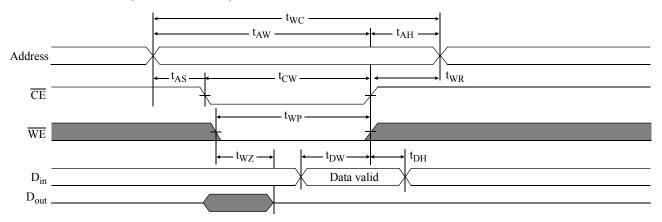
		-]	10	-]	12	-]	15	-2	20		
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Unit	Notes
Write cycle time	t _{WC}	10	—	12	-	15	-	20	_	ns	
Chip enable to write end	t _{CW}	8	_	8	_	10	_	12	_	ns	
Address setup to write end	t _{AW}	8	_	8	_	10	_	12	_	ns	
Address setup time	t _{AS}	0	_	0	_	0	_	0	_	ns	
Write pulse width	t _{WP}	7	_	8	_	9	_	12	_	ns	
Write recovery time	t _{WR}	0	-	0	-	0	-	0	_	ns	
Address hold from end of write	t _{AH}	0	_	0	_	0	_	0	_	ns	
Data valid to write end	t _{DW}	5	_	6	_	8	_	10	_	ns	
Data hold time	t _{DH}	0	-	0	-	0	-	0	_	ns	4, 5
Write enable to output in high Z	t _{WZ}	_	5	_	6	_	7	_	8	ns	4, 5
Output active from write end	t _{OW}	3	—	3	_	3	_	3	_	ns	4, 5

Write cycle (over the operating range)¹¹

Write waveform 1 (WE controlled)^{10,11}



Write waveform 2 (CE controlled)^{10,11}

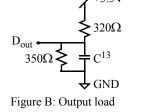




AC test conditions

- Output load: see Figure B
- Input pulse level: GND to 3.0V. See Figure A.
- Input rise and fall times: 2 ns. See Figure A.
- Input and output timing reference levels: 1.5V.

+3.0V
$$90\%$$
 2 ns 10% Figure A: Input pulse



Thevenin equivalent

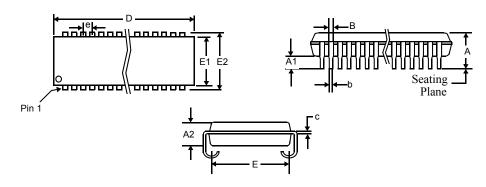
$$D_{out}$$
 +1.72V

Notes

- $1 \quad \text{During } V_{CC} \text{ power-up, a pull-up resistor to } V_{CC} \text{ on } \overline{CE} \text{ is required to meet } I_{SB} \text{ specification.}$
- 2 This parameter is sampled, but not 100% tested.
- 3 For test conditions, see AC Test Conditions, Figures A, B.
- 4 These parameters are specified with CL = 5pF, as in Figures B. Transition is measured $\pm 500mV$ from steady-state voltage.
- 5 This parameter is guaranteed, but not tested.
- $\overline{\text{WE}}$ is High for read cycle.
- 7 $\overline{\text{CE}}$ and $\overline{\text{OE}}$ are Low for read cycle.
- 8 Address valid prior to or coincident with \overline{CE} transition Low.
- 9 All read cycle timings are referenced from the last valid address to the first transitioning address.
- 10 N/A
- 11 All write cycle timings are referenced from the last valid address to the first transitioning address.
- 12 N/A
- 13 C=30pF, except on High Z and Low Z parameters, where C=5pF.

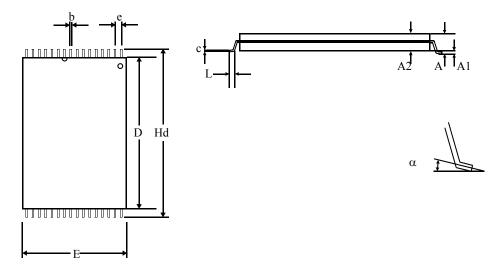
Package diagrams

28-pin SOJ



	28-pi	n SOJ			
	Min	Max			
	in in	ches			
Α	0.128	0.148			
A1	0.026	-			
A2	0.095	0.105			
B	0.026	0.032			
b	0.016	0.020			
с	0.007	0.010			
D	0.720	0.730			
E	0.255	0.275			
E 1	0.295	0.305			
E2	0.330	0.340			
e	0.050 BSC				

28-pin TSOP1



	28-pin	TSOP1
	8 ×13.	4 mm
	Min	Max
Α	1.00	1.20
A1	0.05	0.15
A2	0.91	1.05
b	0.17	0.27
c	0.10	0.20
D	11.70	11.90
e	0.55 n	ominal
E	7.90	8.10
Hd	13.20	13.60
L	0.50	0.70
α	0°	5°



Ordering information

Package / Access time	Temperature	10 ns	12 ns	15 ns	20 ns
Plastic SOJ, 300 mil	Commercial	AS7C3256A-10JC	AS7C3256A-12JC	AS7C3256A-15JC	AS7C3256A-20JC
	Industrial	AS7C3256A-10JI	AS7C3256A-12JI	AS7C3256A-15JI	AS7C3256A-20JI
TSOP 8x13.4mm	Commercial	AS7C3256A-10TC	AS7C3256A-12TC	AS7C3256A-15TC	AS7C3256A-20TC
1501 8x15.4mm	Industrial	AS7C3256A-10TI	AS7C3256A-12TI	AS7C3256A-15TI	AS7C3256A-20TI

Note: Add suffix 'N'to the above part number for lead free parts. (Ex. AS7C3256A-10JIN)

Part numbering system

	AS7C	3	256A	-XX	X	C or I	X
SI	RAM prefix	Voltage: 3 = 3.3V supply	Device number	Access time		Temperature range: C = 0 °C to 70 °C I = -40C to 85C	N= Lead Free Part



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